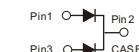
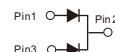


FEATURES

- Power pack
- Metal silicon junction ,majority carrier conduction
- Guard ring for overvoltage protection
- Low power loss ,high efficiency
- High current capability ,low forward voltage drop
- High forward surge capability
- High frequency operation
- Meets MSL Level 1, per J-STD-020, LF MAX peak of 245°C (for TO-263 package)
- Solder bath temperature 275°C maximum, 10s, per JESD22-B106 (for TO-220AB and ITO-220AB package)
- Component in accordance to RoHS 2011/65/EU


TO-220AB

ITO-220AB

TO-263
SR4080LD1


MECHANICAL DATA

- Case: JEDEC TO-220AB、ITO-220AB、TO-263
- Molding compound meets UL94V-0 flammability rating
- Terminals: Lead solderable per J-STD-002 and JESD22-B102
- Polarity: As marked
- Mounting Torque: 10 in-lbs maximum

TYPICAL APPLICATIONS

For use in low voltage ,high frequency inverters ,DC/DC converters, free wheeling ,and polarity protection applications

MAXIMUM RATINGS

(Ratings at 25°C ambient temperature unless otherwise specified)

PRIMARY CHARACTERISTICS	
I _{F(AV)}	2×20A
V _{RRM}	80V
I _{FSM}	300A
V _F at I _F =20.0A,Per leg	0. 62V
I _R	50 μ A
T _{J(MAX)}	150°C
Package	TO-220AB, ITO-220AB, TO-263
Diode variations	Common cathode

Parameter	Symbol	Value	Unit
Maximum repetitive peak reverse voltage	V _{RRM}	80	V
Maximum average forward rectified current (see fig.1)	I _{F(AV)}	20.0	A
		40.0	
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC method at rated TL)	I _{FSM}	300	A
Peak repetitive reverse current per diode at t _p =2 μ s 1KHz	I _{RRM}	0.5	A
Operating junction and Storage temperature range	T _J ,T _{Stg}	-55 to+150	°C
Isolation voltage (ITO-220AB only) from terminals to heatsink t=1 min	V _{AC}	1500	V

RATINGS AND CHARACTERISTIC OF SR4080LCT,SRF4080LCT,SR4080LD1

ELECTRICAL CHARACTERISTICS ($T_A=25^\circ\text{C}$ Unless otherwise noted)

Parameter	Test Conditions		Symbol	TYP.	MAX.	Unit
Instantaneous forward voltage	$T_A=25^\circ\text{C}$	$I_F=5.0\text{A}$	V_F ¹⁾	0.44	—	V
		$I_F=10.0\text{A}$		0.50	—	
		$I_F=20.0\text{A}$		0.62	0.68	
	$T_A=125^\circ\text{C}$	$I_F=5.0\text{A}$		0.36	—	
		$I_F=10.0\text{A}$		0.46	—	
		$I_F=20.0\text{A}$		0.60	—	
		$T_A=25^\circ\text{C}$		50	100	$\mu\text{ A}$
		$T_A=100^\circ\text{C}$		5	—	mA
		$T_A=125^\circ\text{C}$		20	—	
Typical junction capacitance	$4\text{V}, 1\text{MHz}$		C_J	880		pF

Notes: 1.Pulse test: 300 μs pulse width, 1% duty cycle

2.Pulse test: pulse width $\leqslant 40\text{ms}$

THERMAL CHARACTERISTICS

Parameter	Symbol	SR4080LCT	SRF4080LCT	SR4080LD1	Unit
Typical thermal resistance ³⁾	$R_{\theta JC}$	2.5	4.5	2.5	$^\circ\text{C}/\text{W}$

3.Thermal resistance from junction to case

AVAILABALE PACK INFORMATION

Product code	Pack	Box Size L×W×H(mm)	Quantity(pcs/box)	Carton SizeL×W×H(mm)	Quantity(box/carton)
SR4080LCT-TO-220AB	P/T	558×148×38	1000	565×225×170	5
SRF4080LCT-ITO-220AB	P/T	558×148×38	1000	565×225×170	5
SR4080LD1-TO-263	P/T	558×148×38	1000	565×225×170	5

RATINGS AND CHARACTERISTIC OF SR4080LCT,SRF4080LCT,SR4080LD1

FIG.1-FORWARD CURRENT DERATING CURVE

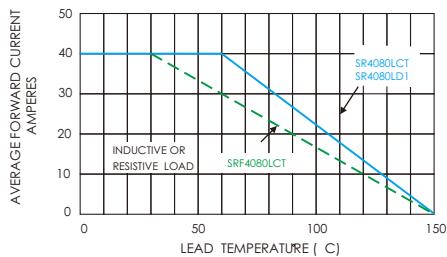


FIG.2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

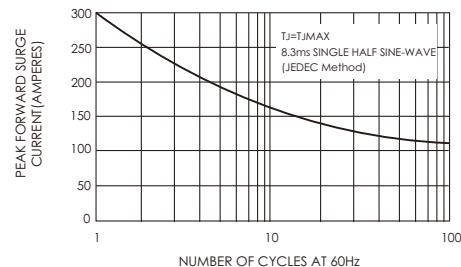


FIG.3-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

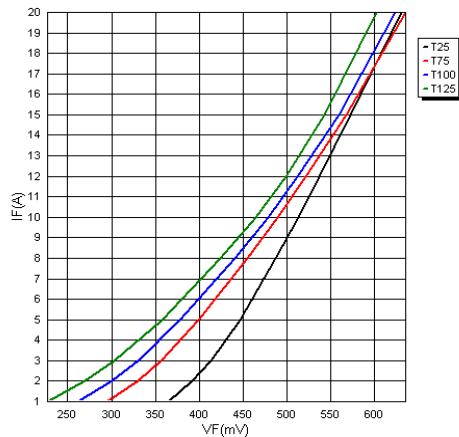


FIG.4-TYPICAL REVERSE CHARACTERISTICS

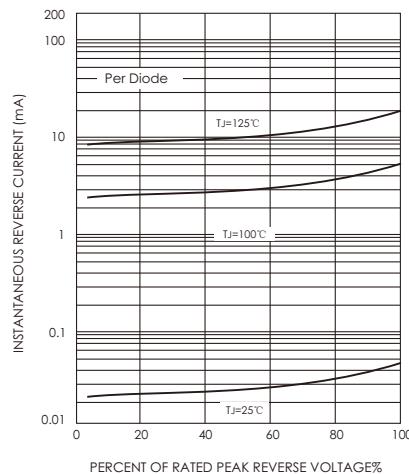
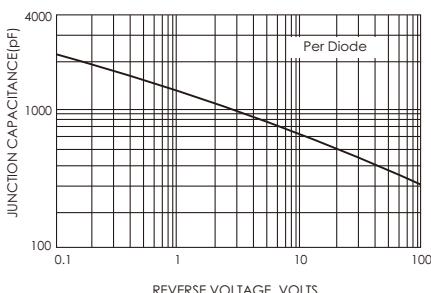
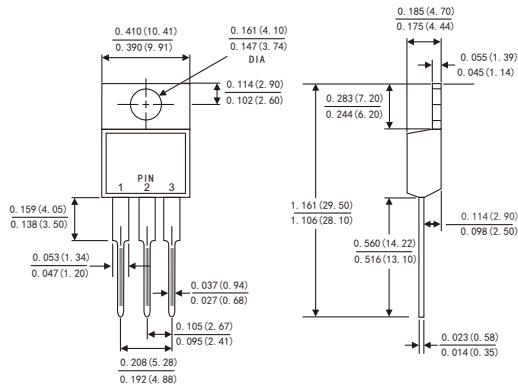


FIG.5-TYPICAL JUNCTION CAPACITANCE

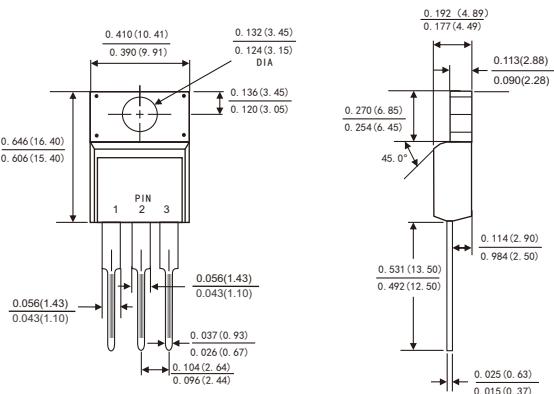


PACKAGE OUTLINE DIMENSIONS

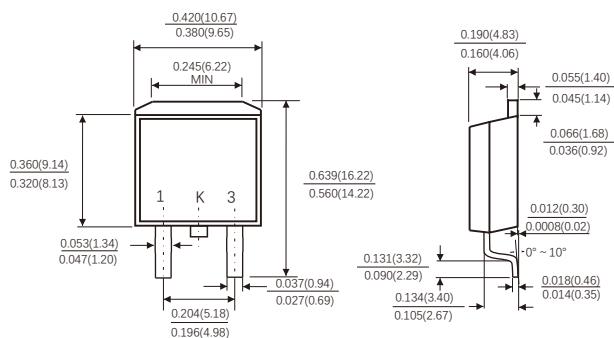
TO-220AB



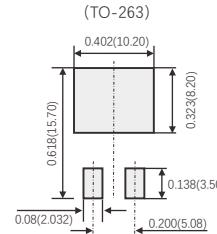
ITO-220AB



TO-263



Suggested Pad Layout



(设计者可参考推荐值根据具体工艺
要求自行确定适当的焊盘尺寸)
(Designers can refer to the recommended
values according to the manufacturing process
requirements to determine the appropriate pad size)

Dimensions in inches and (millimeters)